

CHEMRAZ[®]

(FFKM) Overview





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	Chemraz [®] Compound	Primary Industry	Suggested Applications	Features & Benefits	Service Temperature Range	Chemical Compatibility
	504	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Valves Pump housings Sampling/metering equipment Reactors Mixers Controls/instrumentation Sprayers/dispensers Couplings 	 Broad chemical compatibility for use with wide range of harsh solutions Lower compression set increases ability to handle temp & pressure variations, shaft misalignment, & o-ring shrinkage Low temp capabilities (-30°C/-22°F) 	-30°C to 230°C (-22°F to 446°F)	 Acids Caustics Aldehydes Esters Aromatics Hot water/ steam Amines Methanol Ketones TBA MTBE
General Purpose	505	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Valves Pump housings Reactors Compressors Sampling/metering equipment Mixers Controls/instrumentation Sprayers/dispensers Coupling 	 Broad chemical compatibility for use with a wide range of harsh solutions Lower compression set increases ability to handle temp and pressure variations, shaft misalignment, & o-ring shrinkage 	-30°C to 230°C (-22°F to 446°F)	 Acids Caustics Aldehydes Esters Ethers Aromatics Hot water/ steam Amines Methanol Ketones TBA MTBE
General	510	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Valves Pump housings Sampling/metering equipment Reactors Mixers Controls/instrumentation Sprayers/dispensers Couplings Compressors 	 Broad chemical compatibility Low temp capabilities (-30°C/-22°F) Higher hardness and density reduces likelihood of gap extrusion 	-30°C to 230°C (-22°F to 446°F)	 Acids Caustics Aldehydes Esters Aromatics Hot water/ steam Amines Methanol Ketones TBA MTBE
	513	Semiconductor	Dry wafer processing equipment seals: Door seals Slit valves Window seals Isolator valve seals Lid seals Gas inlet seals KF fitting seals	 Good plasma resistance Good physical properties Minimal contamination Excellent performance history as "universal product" 	-30°C to 210°C (-22°F to 410°F)	-



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	514	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Valves Pump housings Reactors Mixers Sprayers/dispensers Couplings 	 No carbon black residue Low-temp capabilities (-30°C/-22°F) 	-30°C to 220°C (-22°F to 428°F)	-
Purpose	520	Semiconductor	Dry wafer processing equipment seals: Door seals Slit valves Isolator valve seals Lid seals Gas inlet seals KF fitting seals	 Excellent plasma resistance Outstanding physical properties Low contaminants Withstands higher sealing loads Excellent performance history in higher temp applications 	-30°C to 240°C (-22°F to 464°F)	-
General Purpose	543	Semiconductor	Dry wafer processing equipment seals: Door seals Slit valves Window seals Isolator valve seals Lid seals Gas inlet seals KF fitting seals	 Good plasma resistance Good physical properties Minimal contamination Excellent performance as a "universal product" 	-30°C to 210°C (-22°F to 410°F)	_
	550	Semiconductor	Aqueous wafer processing equipment seals: Valve seals Fitting & union seals Gaskets Regulator seals Filter seals	 Good chemical resistance & physical properties Used where contamination requirements are less critical Excellent performance history 	-30°C to 210°C (-22°F to 410°F)	-



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General Purpose	551	Semiconductor	Aqueous wafer processing equipment and chemical/DI water distribution system seals: • Valve seals • Fitting and union seals • Gaskets • Regulator seals • Filter seals • Dispensing seals	 Broad chemical compatibility High-temp capability Excellent compression set Breadth of capabilities allows for standardization on one material & reduces inventory line items Longer & better seal integrity in seal applications; lower overall equipment cost of operation 	-12°C to 316°C (-10°F to 600°F)	-
	584	Oil & GasChemical ProcessingIndustrial	Mechanical sealsSampling/metering equipmentPump housings	 Superior chemical resistance for use in strong oxidation fluids & hot aqueous solutions as well as chlorine & ozone No carbon black residue 	-30°C to 220°C (-22°F to 428°F)	-
	592	Semiconductor	Dry wafer processing equipment seals: Slit valve seals Lid seals Endpoint windows Valve seals Window seals Isolator valve seals Gas inlet seals Bell jar seals KF fitting seals	 Excellent physical properties Inert mineral filler system provides excellent resistance to plasma attack Good static & dynamic performance 	-30°C to 240°C (-22°F to 464°F)	-
	600	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Pump housings Reactors Mixers Valves Compressors 	 High durometer & high-density material helps withstand high pressure & harsh environments Broad chemical resistance range High-temperature capability 	-20°C to 260°C (-4°F to 500°F)	-



	Chemraz® Compound	Primary Industry	Suggested Applications	Features & Benefits	Service Temperature Range	Chemical Compatibility
General Purpose	605	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Pump housings Reactors Mixers Valves Compressors Sampling/metering equipment Controls/instrumentation Sprayers/dispensers Diaphragms Couplings 	 High-temperature capability Excellent compression set resistance Broad chemical compatibility for use with a wide range of harsh solutions 	-20°C to 260°C (-4°F to 500°F)	 Acids Caustics Aldehydes Esters Ethers Aromatics Hot water/ steam Amines Methanol Ketones TBA MTBE
Resistance	526	Oil & Gas Chemical Processing Industrial	PumpsMechanical sealsValvesDownhole completion toolsCompressors	 Excellent RGD resistance Broad chemical resistance Meets RGD requirements of Total GS EP PVV 142 & NACE TM0297 ISO 23936-2/ NORSOK M-710 	-20°C to 250°C (-4°F to 482°F)	Sour gasAcidsCausticsHot water/ steam
Decompression R	566 LT	Oil & Gas Chemical Processing Industrial	 Deepwater drilling tools Subsea equipment Downhole completion tools used in water injection wells 	 Exceptional performance in extreme low temps Superior resistance to hostile reservoir chemistries Excellent compression set & thermal shock resistance 	-40°C to 230°C (-40°F to 446°F)	-
Rapid Gas Decom	678	Oil & Gas Chemical Processing Industrial	 Wireline tools High pressure applications Subsea Downhole Completion tools Downhole drilling tools 	 Excellent RGD resistance Exceptional performance in extreme low temps Superior resistance to hostile reservoir chemistries, drilling fluid, production chemicals Excellent compression set & thermal shock resistance Meet RGD requirements of ISO 23936-2/ NORSOK M-710 	-40°C to 230°C (-40°F to 446°F)	-
Aerospace	676	Aerospace	Perfluoroelastomer (FFKM) compound where ultra high- temperature &/or excellent chemical compatibility is required	Meets AMS 7257E	-18°C to 324°C (0°F to 615°F)	Strong chemical resistance to all common Aerospace fluids



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	555	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Valves Pump housings Sampling/metering equipment Reactors Quick connect couplings Mixers Controls/instrumentation Compressors Sprayers/dispensers 	 Superior high temp capability (316°C/600°F) Broad chemical resistance in wide range of media Excellent compression set maintains seal integrity in wide temp & pressure variations as well as vibration 	-12°C to 316°C (10°F to 600°F)	 Acids Caustics Aldehydes Esters Ethers Aromatics Hot water/steam Amines Methanol Ketones Mixed process streams TBA MTBE
Φ	562	Oil & GasChemical ProcessingIndustrial	 Completion tools Electrical submersible pumps Mechanical seals 	 Excellent compression set resistance Excellent steam & chemical resistance 	-12°C to 316°C (10°F to 600°F)	 Steam Reservoir fluids with high H₂S Caustics Hot water/steam
High Temperature	615	Oil & GasChemical ProcessingIndustrial	 Mechanical seals Process control instruments Heat exchangers Valves Agitators & mixers Pumps Couplings 	 Low compression set at continuous temps up to 324°C (615°F) Ability to handle severe thermal cycles Excellent chemical resistance 	-18°C to 324°C (0°F to 615°F)	 Inorganic & organic chemicals Acids Reagents Heat transfer fluids Hydrocarbons
	694	Oil & GasChemical ProcessingIndustrial	 Electrical submersible pumps Downhole completion tools 	 Superior resistance to hostile reservoir chemistries, drilling fluid, additives, & production chemicals Excellent compression set & thermal shock resistance Increased reliability of components used in critical steam & hightemp environments 	-12°C to 316°C (10°F to 600°F)	 Inorganic & organic chemicals Acids Hydrocarbons
	SFX	Industrial Semiconductor	Subfab applications including abatement units, exhaust lines, pumps and valves	 Broad chemical resistance to typical Subfab effluents Optimized physical properties for long life in static vacuum fittings 	-12°C to 300°C (10°F to 572°F)	ChlorineFluorineHydrogenOxygen



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USP VI/FDA	517	Life Science	 Mechanical seals Sampling/metering equipment Pump housings 	 No carbon black residue Low-temp capabilities (-30°C/-22°F) 3-A® & FDA compliant, meeting the highest purity standards 	-30°C to 220°C (-22°F to 428°F)	-
	585	Life Science	 Mechanical seals Sampling/metering equipment Pump housings Reactors Mixers Valves Controls/instrumentation Couplings 	 Superior chemical resistance for use in strong oxidation fluids & hot aqueous solutions as well as chlorine & ozone No carbon black residue 3-A® & FDA compliant, meeting the highest purity standards 	-30°C to 220°C (-22°F to 428°F)	-
	625	Life Science	 Mechanical seals Valves Pumps Mixers fermenters Biomedical equipment Couplings Filters Dryers Agitators Sanitary seals WFI gaskets 	 Superior high-temperature properties Outstanding hot water & steam resistance 3-A® & FDA compliant, meeting the highest purity standards 	-20°C to 260°C (-4°F to 500°F)	 Fuel handling CIP/SIP operations Pharmaceutical manufacturing
lications	570	Semiconductor	Aqueous wafer processing equipment seals: Valve seals Fitting & union seals Gaskets Regulator seals Filter seals Dispensing seals	 Very low contaminants Extended performance & added reliability Good physical properties Excellent performance history 	-30°C to 210°C (-22°F to 410°F)	 Acids Solvents Ultrapure H₂O
Wet Applications	571	Semiconductor	Aqueous wafer processing equipment seals: Valve seals Fitting & union seals Gaskets Regulator seals Filter seals Dispensing seals	 Very low contaminants Extended performance & added reliability Good physical properties Excellent performance history 	-30°C to 210°C (-22°F to 410°F)	 Acids Solvents Ultrapure H₂O



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sition/Etch	629	Semiconductor	Dry wafer processing equipment seals: Slit valve seals Lid seals Endpoint windows Valve seals Window seals Isolator valve seals Gas inlet seals Bell jar seals KF fitting seals	 Exceptional plasma resistance in oxygen & fluorine environments Minimal particulation & surface degradation High purity, very low metallic ion content High elasticity allows conformance to hardware & easier seal installation 	-20°C to 260°C (-4°F to 500°F)	-
Clean-Deposition/Etch	639	Semiconductor	Dry wafer processing equipment seals: • Endpoint windows • Bell jar seals • Valve seals • KF fitting seals • Window seals • Isolator valve seals • Lid seals • Gas inlet seals • Slit valve seals • Chamber seals	 Exceptional plasma resistance in oxygen & fluorine environments Minimal particulation & surface degradation High purity, very low metallic ion content 	-20°C to 260°C (-4°F to 500°F)	-
position	547	Semiconductor	Dry wafer processing equipment seals: Lid seals Endpoint windows Gas inlet/outlet seals Chamber seals Valve seals Slit valve seals Isolation valve seals Gasket seals Dispersing seals Regulator seals Filler seals	 Exceptional plasma resistance in fluorine environments Minimal particulation & surface degradation High purity, very low metallic ion content Excellent compression set for repeated use 	Max service temperature: 300°C (572°F)	-
Clean-Deposit	XRZ	Semiconductor	NF ₃ plasma cleaning equipment seals: • Chamber seals • Endpoint windows • Gas inlet/outlet seals • Gate valve seals • Isolator valve seals • Reactant delivery system seals • Reaction chamber lid seals • Slit valve seals	 Outstanding plasma resistance in highly corrosive fluorine environments with minimal seal degradation Excellent surface resistance for minimal particulation & sealing integrity High purity for minimal contamination risk Minimal compression set at elevated temps ensures seal integrity Extended equipment uptime with added reliability in dry applications 	Max service temperature: 300°C (572°F)	_

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	657	Semiconductor	Dry wafer processing equipment seals: • Endpoint windows • Bell jar seals • Valve seals • KF fitting seals • Window seals • Isolator valve seals • Lid seals • Gas Inlet seals • Slit valve seals • Chamber seals	 Excellent plasma resistance in a variety of aggressive chemical environments Minimal particulation Withstands high service temps up to 280°C (536°F) with excursions to 300°C (572°F) 	-18°C to 324°C (0°F to 615°F)	-
	E38	Semiconductor	Dry wafer processing equipment seals: Bonded gate seals Chamber seals	 Minimal contamination Withstands a variety of aggressive chemicals Excellent physical properties Low metal ion content Unlimited design flexibility 	-20°C to 260°C (-4°F to 500°F)	-
Clean Etch	XPE-HP	Semiconductor	Dry wafer processing equipment seals: Chamber and slit valve seals Endpoint windows Gas inlet/outlet seals Gate and isolator valve seals Reactant delivery system seals Reaction chamber lid seals	 High UV & ozone resistance enables next generation process technology insertions Superior O₂ plasma resistance results in improved product integrity High-temp capability Reduced erosion & particulation Decreased maintenance & replacement requirements Excellent compression set 	Max service temperature: 255°C (491°F)	O2 plasmaOzoneFluorine-basedplasmas
	XPE	Semiconductor	Dry wafer processing equipment seals: Chamber & slit valve seals Endpoint windows Gas inlet/outlet seals Gate and isolator valve seals Reactant delivery system seals Reaction chamber lid seals	 High-temperature capability enables future technology & next generation applications Superior O₂ plasma resistance resulting in improved product integrity High CF₄ plasma resistance Reduced product weight loss Decreased maintenance & replacement requirements Excellent compression set performance 	Max service temperature: 280°C (536°F)	Fluorine -based plasmas



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Low Temperature	564 LT	 Oil & Gas Chemical Processing Industrial 	 Deepwater drilling tools Subsea equipment Downhole completion tools used in water injection wells 	 Exceptional performance in extreme low temps Superior resistance to hostile reservoir chemistries Excellent compression set & thermal shock resistance 	-40°C to 230°C (-40°F to 446°F)	_
BSV - Deposition/Etch	656	Semiconductor	Dry wafer processing equipment seals: Bonded slit valve gates Chamber seals Window seals Gas inlet seals Lid seals	Excellent plasma resistance Soft material for low sealing forces & tolerance stackups High purity, very low metallic ion content	-20°C to 232°C (-4°F to 450°F)	_

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Greene Tweed

1684 South Broad Street | PO Box 1307 | Lansdale PA 19446 USA

Phone: +1.215.256-9521 | Fax: +1.215.256.0189 | Toll Free: 1.800.220.4733

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